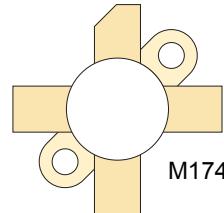


## RF POWER VERTICAL MOSFET



The VRF152 is a gold-metallized silicon n-channel RF power transistor designed for broadband commercial and military applications requiring high power and gain without compromising reliability, ruggedness, or inter-modulation distortion.

### FEATURES

- Improved Ruggedness  $V_{(BR)DSS} = 130V$
- 150W with 22dB Typical Gain @ 30MHz, 50V
- 150W with 14dB Typical Gain @ 175MHz, 50V
- Excellent Stability & Low IMD
- Common Source Configuration
- 30:1 Load VSWR Capability at Specified Operating Conditions
- Nitride Passivated
- Refractory Gold Metallization
- Low  $R_{DS(on)}$  Replacement for MRF151/ BLF177/ SD2941
- RoHS Compliant

### Maximum Ratings

All Ratings:  $T_c = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	VRF152	Unit
$V_{DSS}$	Drain-Source Voltage	130	V
$I_D$	Continuous Drain Current @ $T_c = 25^\circ\text{C}$	20	A
$V_{GS}$	Gate-Source Voltage	$\pm 40$	V
$P_D$	Total Device dissipation @ $T_c = 25^\circ\text{C}$	300	W
$T_{STG}$	Storage Temperature Range	-65 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	200	

### Static Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V$ , $I_D = 50\text{mA}$ )	130			V
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>1</sup> ( $V_{GS} = 10V$ , $I_D = 10A$ )		0.13	0.20	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 100V$ , $V_{GS} = 0V$ )			50	$\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage Current ( $V_{DS} = \pm 20V$ , $V_{GS} = 0V$ )			1.0	$\mu\text{A}$
$g_{fs}$	Forward Transconductance ( $V_{DS} = 10V$ , $I_D = 5A$ )	5.0	6.2		mhos
$V_{GS(TH)}$	Gate Threshold Voltage ( $V_{DS} = 10V$ , $I_D = 100\text{mA}$ )	2.9	3.6	4.4	V

### Thermal Characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance			0.60	$^\circ\text{C}/\text{W}$

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

## Dynamic Characteristics

VRF152

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 50V$ $f = 1MHz$		383		pF
$C_{oss}$	Output Capacitance			215		
$C_{rss}$	Reverse Transfer Capacitance			20		

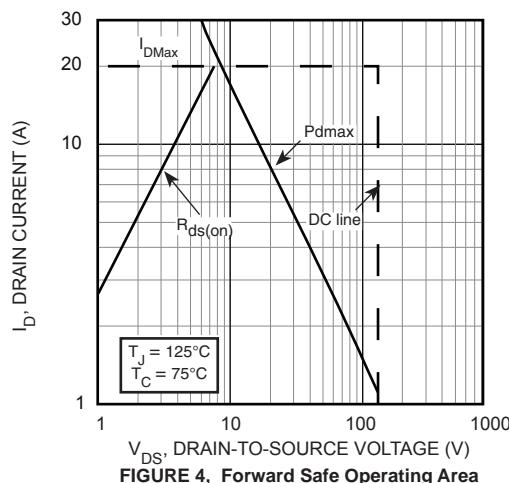
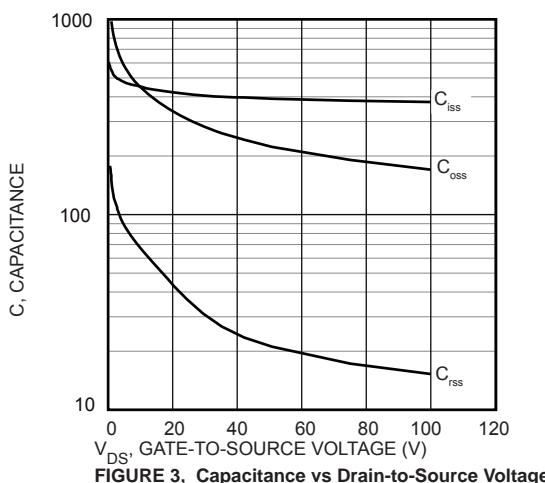
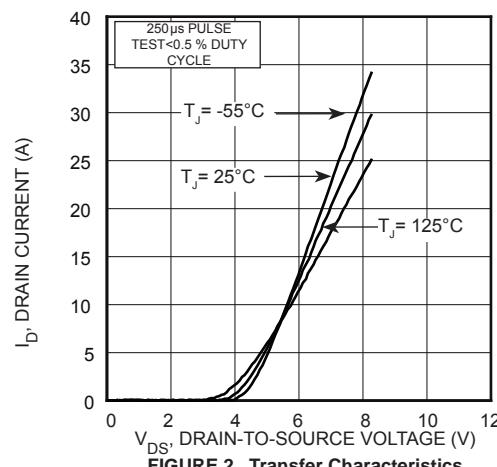
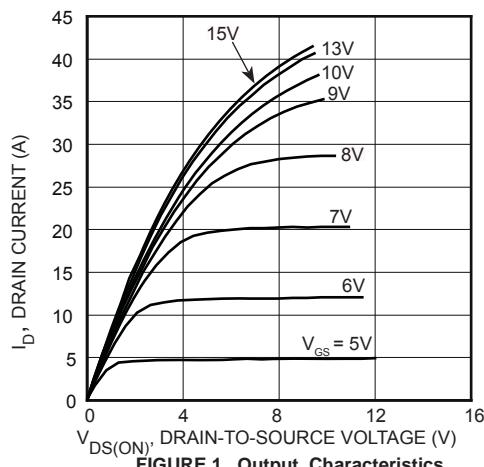
## Functional Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$G_{PS}$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}$	18	22		dB
$G_{PS}$	$f = 175MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W$		13		
$\eta_D$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}$		50		%
$IMD_{(d3)}$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}^1$		-30		
$IMD_{(d11)}$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}$		-60		dBc
$\Psi$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}$ 30:1 VSWR - All Phase Angles	No Degradation in Output Power			

1. To MIL-STD-1311 Version A, test method 2204B, Two Tone, Reference Each Tone

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

## Typical Performance Curves



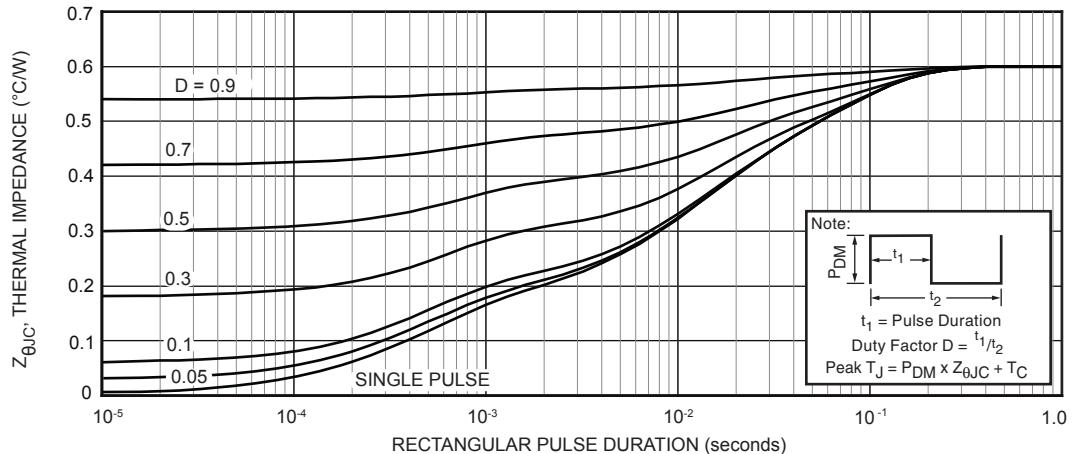
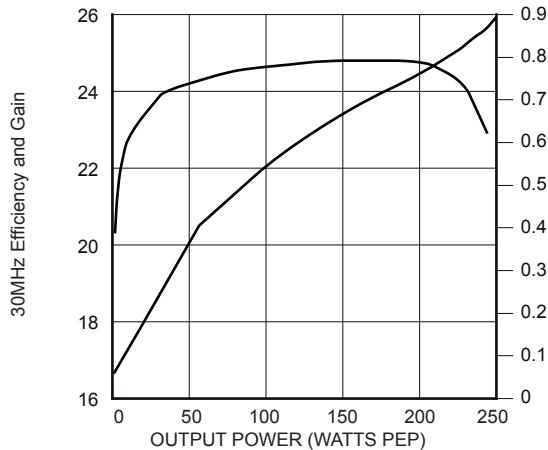
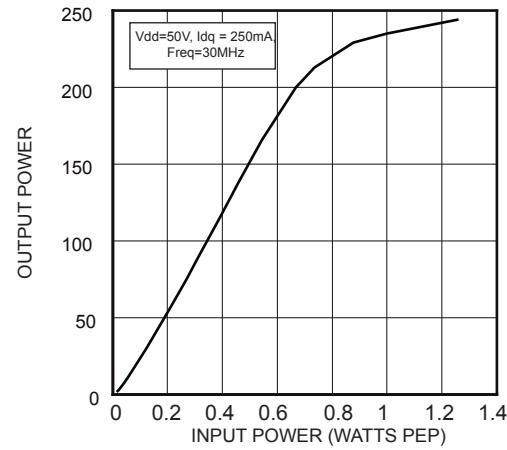
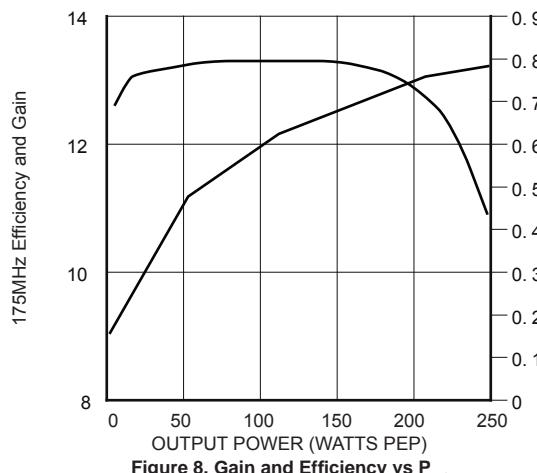
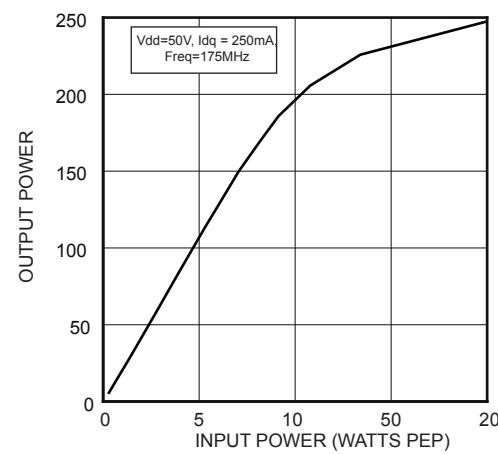
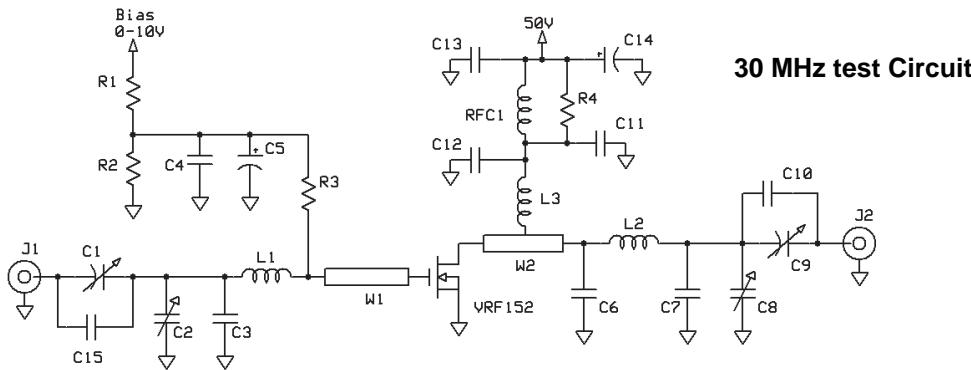
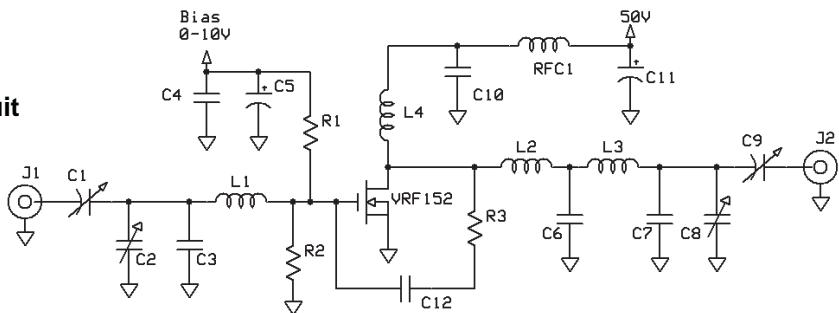


Figure 5. Maximum Effective Transient Thermal Impedance Junction-to-Case vs Pulse Duration

Figure 6. Gain and Efficiency vs  $P_{out}$ Figure 7.  $P_{out}$  versus  $P_{in}$ Figure 8. Gain and Efficiency vs  $P_{out}$ Figure 9.  $P_{out}$  versus  $P_{in}$

**30 MHz test Circuit**

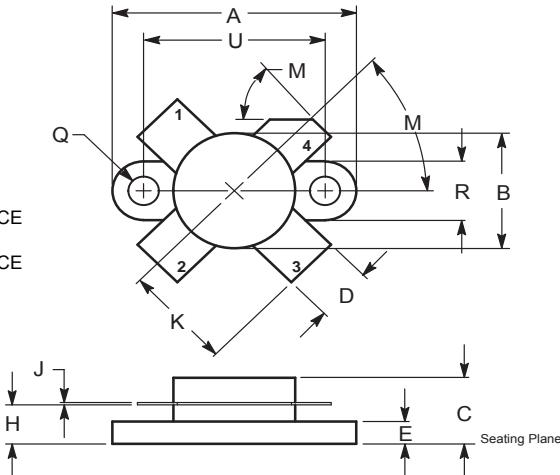
C1,2,8,9 - ARCO 463 20-180pF  
 C3,7 - 120 pF ATC 100B  
 C4,11-13 - 0.1uF 100V SMT  
 C5 - 1 uF 15WY tant  
 C6, C15 - 47pF ATC 100B  
 C10 - 150pF ATC 100B  
 C14 - 15uF 100V Elect  
 W1 W2 - printed line 0.23"x 0.7"  
 L1 - 4t #20 ga .25" d x .16" L ~120nH  
 L2 - 5t #14 ga .312" dia x .45" ~135nH  
 L3 - 7 turns #16 ga 5/16" ID tight. ~250nH  
 R1 R2 - 2.2k ohm 1/4W  
 R3 - 22 ohm 1W SMT  
 R4 - 2.2 ohm 2W  
 PCB = FR-4 fiberglass-epoxy er = 4.6

**175 MHz test Circuit**

C1 C2 C8 - ARCO 463  
 C3 C7 - 25 pF ATC 100B  
 C4 C10 C12 - 0.1uF 100V SMT  
 C5 - 1 uF 15WY tant  
 C6 - 250 pF ATC 100B  
 C9 - ARCO 462  
 C11 - 15uF 100V Elect  
 L1 - 3/4" #18 ga into Hairpin  
 L2 - printed line 0.2" W x 0.5" L  
 L3 - 1" #16 ga into Hairpin  
 L4 - 2 turns #16 ga. 5/16" ID  
 R1 R2 - 150 ohm 1W  
 R3 - 470 ohm 3W, Panasonic ECG  
 RFC1 Fair-Rite 2961666631 (VK200-4B)

**.5" SOE Package Outline  
All Dimensions are  $\pm .005$** 

PIN 1 - SOURCE  
 PIN 2 - GATE  
 PIN 3 - SOURCE  
 PIN 4 - DRAIN



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.096	0.990	24.39	25.14
B	0.465	0.510	11.82	12.95
C	0.229	0.275	5.82	6.98
D	0.216	0.235	5.49	5.96
E	0.084	0.110	2.14	2.79
H	0.144	0.178	3.66	4.52
J	0.003	0.007	0.08	0.17
K	0.435		11.0	
M	45° NOM		45° NOM	
Q	0.115	0.130	2.93	3.30
R	0.246	0.255	6.25	6.47
U	0.720	0.730	18.29	18.54

Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 6,939,743, 7,352,045 5,283,201 5,801,417 5,648,283 7,196,634 6,664,594 7,157,886 6,939,743 7,342,262 and foreign patents. US and Foreign patents pending. All Rights Reserved.